

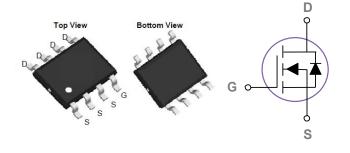


100V N-Channel MOSFET

General Description

The KSP4104 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible onresistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

SOP-8 Pin Configuration



Product Summary

V_{DS} (V)	$\mathbf{R}_{DS(on)}$ (m Ω)	I _D (A)
100	92 at VGS = 10 V	5.3
	98 at V _{GS} = 4.5 V	3.6

Features

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Applications

• Industrial power supplies and LED backlighting

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	100	V
Vgs	Gate-Source Voltage	±20	V
1	Drain Current – Continuous (Tc=25℃)	5.3	A
lD	Drain Current – Continuous (Tc=100℃)	3.6	A
Ы	Drain Current – Pulsed ¹	26	А
) _	Power Dissipation (Tc=25°C)	2.5	W
Po	Power Dissipation (Tc=100°C)	0.1	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction to ambient		57	°C/W
Rejc	Thermal Resistance Junction to Case		6.3	сw

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Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	100			V
IDSS	Drain-Source Leakage Current	V _{DS} =100V , V _{GS} =0V , T _J =25°C			1	uA
		V _{DS} =100V , V _{GS} =0V , TJ=125℃			20	uA
Igss	Gate-Source Leakage Current	V_{GS} = $\pm 20V$, V_{DS} = $0V$			±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =5A		92	115	mΩ
TOS(ON)		V _{GS} =4.5V , I _D =3A		98	127	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.0	1.8	3	V
gfs	Forward Transconductance	V _{DS} =5V , I _S =5A		20		S

Dynamic and switching Characteristics

Qg	Total Gate Charge		 18	
Q _{gs}	Gate-Source Charge	V _{DS} =50V , V _{GS} =10V , I _D =4A	 7	 nC
Q_{gd}	Gate-Drain Charge		 9	
T _{d(on)}	Turn-On Delay Time		 9	
Tr	Rise Time	Vbs=50V, RL=16.7Ω	 4.6	 ns
$T_{d(off)}$	Turn-Off Delay Time	Vgs=10V ,Rg=3Ω	 31	 115
Tf	Fall Time		 5	
Ciss	Input Capacitance		 820	
Coss	Output Capacitance	V_{DS} =50V , V_{GS} =0V , F=1MHz	 85	 pF
C _{rss}	Reverse Transfer Capacitance		 62	

Drain-Source Diode Characteristics and Maximum Ratings

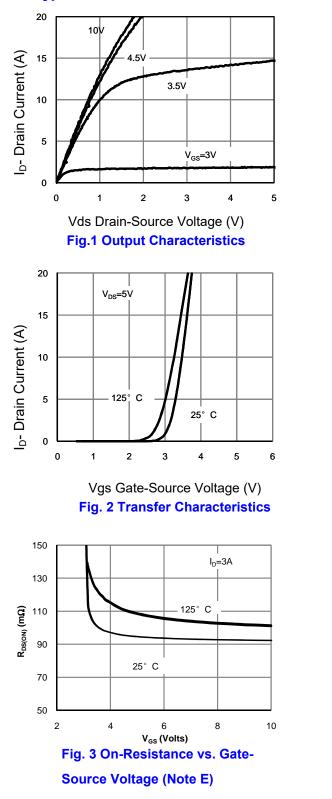
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current	$V_G=V_D=0V$, Force Current			5.3	А
lsм	Pulsed Source Current				16	А
Vsd	Diode Forward Voltage	V _{GS} =0V , Is=1A , Tյ=25℃			1.2	V

Note :

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



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Typical Electrical and Thermal Characteristics (Curves)

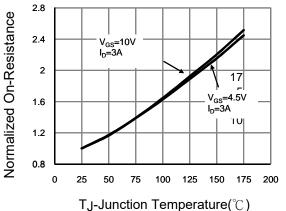


Fig. 4 Rdson-JunctionTemperature

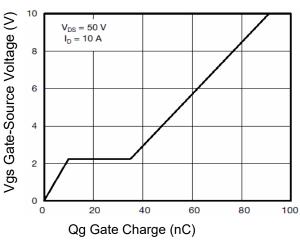
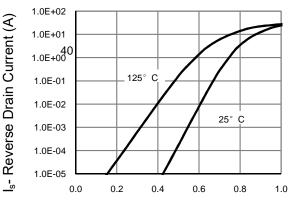


Fig. 5 Gate Charge



Vsd Source-Drain Voltage (V) Fig. 6 Source- Drain Diode Forward

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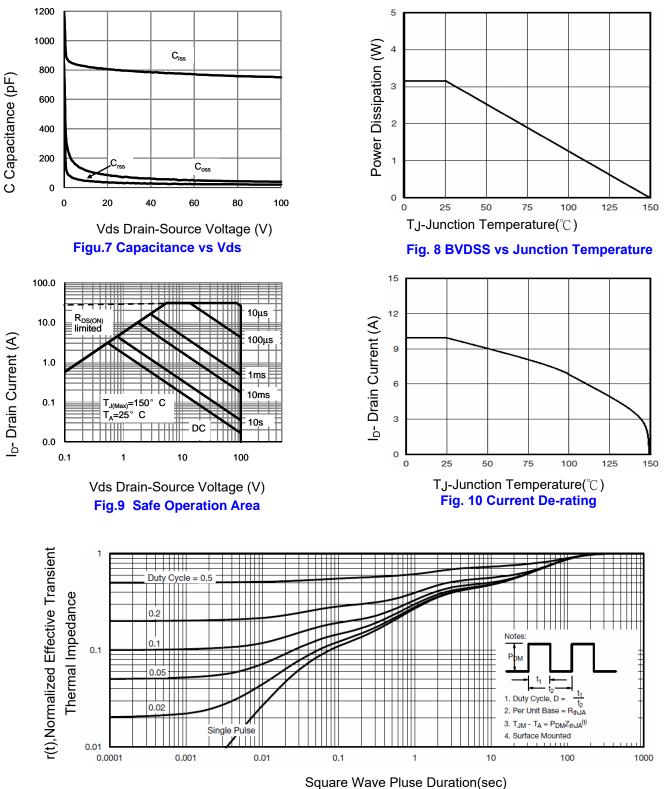


Fig.11 Normalized Maximum Transient Thermal Impedance



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